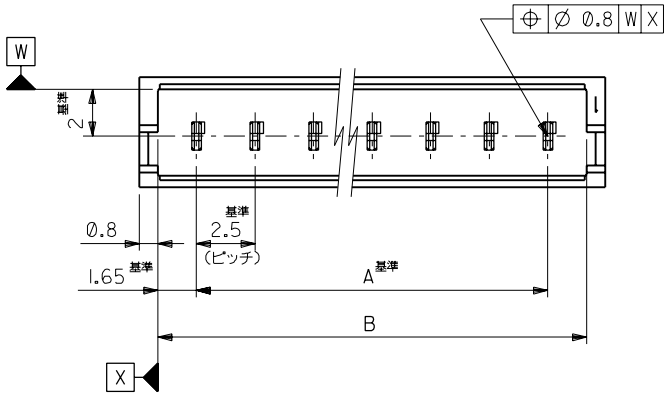
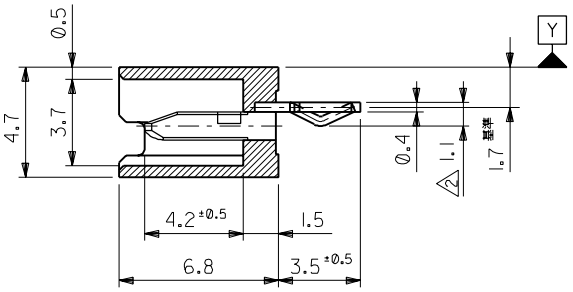
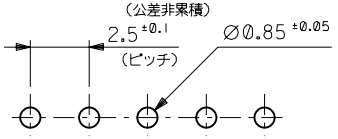
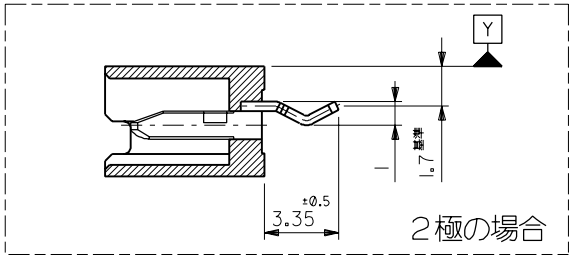
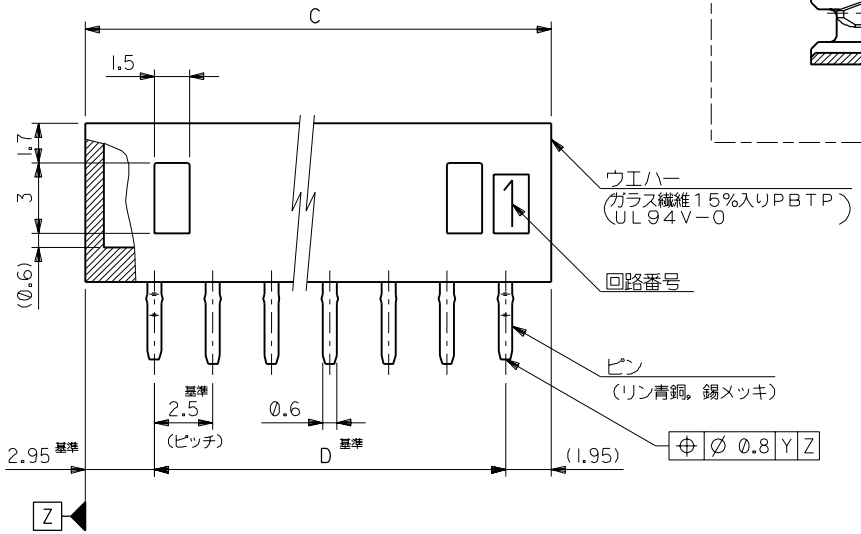






基板取付穴推奨寸法
(基板厚：1.6)





D	C	B	A	EDP NO.	ENG. NO.	極数
35	39.9	38.3	35	39-27-6153	5483-15AX	15
32.5	37.4	35.8	32.5	-6143	-14AX	14
30	34.9	33.3	30	-6133	-13AX	13
27.5	32.4	30.8	27.5	-6123	-12AX	12
25	29.9	28.3	25	-6113	-11AX	11
22.5	27.4	25.8	22.5	-6103	-10AX	10
20	24.9	23.3	20	-6093	-09AX	9
17.5	22.4	20.8	17.5	-6083	-08AX	8
15	19.9	18.3	15	-6073	-07AX	7
12.5	17.4	15.8	12.5	-6063	-06AX	6
10	14.9	13.3	10	-6053	-05AX	5
7.5	12.4	10.8	7.5	-6043	-04AX	4
5	9.9	8.3	5	-6033	-03AX	3
2.5	7.4	5.8	2.5	39-27-6023	5483-02AX	2

注記

1. 嵌合相手： 5480-N

2 キンクは両端のソルダーテールのみとする。

角度 ANGLE	±3°
30 以上 OVER	±0.3
10 以上 OVER 30 未満 UNDER	±0.25
10 未満 UNDER	±0.2
一般公差 GENERAL TOLERANCES	

記号 LTR	変更内容 REVISION RECORD	DR.	日付 DATE
F	変更 (J91070)	H.H	'89/12/20
E	再作図 (J80651)	H.H Y.Y	'88/8/5

REVISE ONLY ON CAD SYSTEM

材料 MATERIAL	図中参照
仕上げ FINISH	
適用電線範囲 WIRE RANGE	
被覆外径 INS. RANGE	
DRAWN BY '88/7/28 H.HIRAMOTO	CHK'D BY '91/08/30 M.FUKUSHIMA
APP'D BY '91/08/30 M.ENOMOTO	尺度 SCALE 5 - 1

MOLEX-JAPAN CO.,LTD. 日本モレックス株式会社

EDP. NO. 39-27-6**3

ENG. NO. SD-5483-NAX REV F

TITLE 名称 2.5 LOW PROFILE WAFER ASS'Y WITH KINK

5483.S12 A

ENG. NO SD-5483-NAX

EDP NO. 39-27-6**3

:MM DIMENSIONS IN METRIC DO NOT SCALE DRAWING

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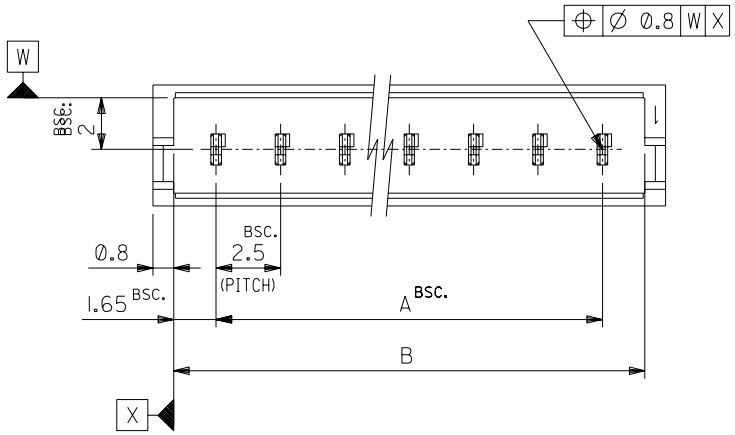
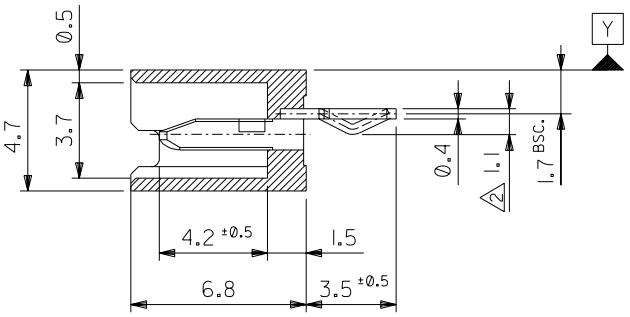
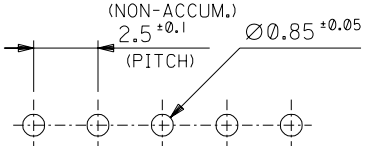
ENG. NO SD-5483-NAX

EDP NO. 39-27-6**3

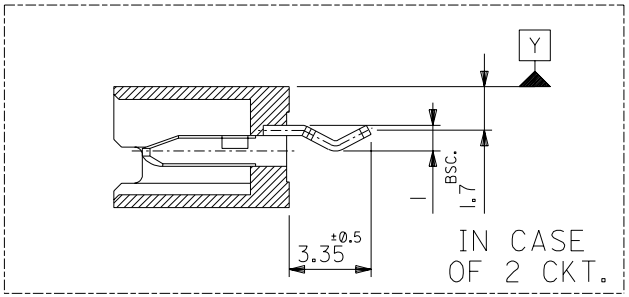
:MM DIMENSIONS IN METRIC DO NOT SCALE DRAWING

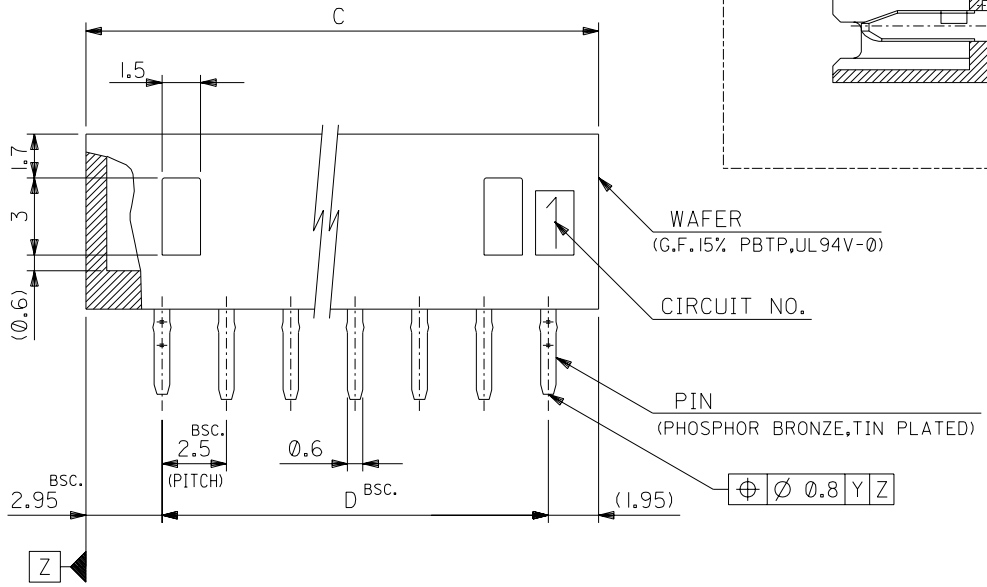






RECOMMENDED P.C.B. HOLE DIMENSIONS
(t=1.6)





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5	9.9	8.3	5	-6033	-03AX	3
2.5	7.4	5.8	2.5	39-27-6023	5483-02AX	2
D	C	B	A	EDP NO.	ENG. NO.	NO.OF CKTS.

NOTES

1. MATES WITH : 5480-N
2. KINK,TO BE APPLIED FOR THE BOTH END OF TERMINAL.

角度 ANGLE	±3°						
30 以上 OVER	±0.3	F	REVISED (J91070)	H.H		'89/12/20	
10 以上 OVER 30 未満 UNDER	±0.25	E	REDRAWN (J80651)	H.H	Y.Y	'88/8/5	
10 未満 UNDER	±0.2	記号 LTR	変更内容 REVISION RECORD	DR.	CHK.	日付 DATE	
一般公差 GENERAL TOLERANCES		REVISE ONLY ON CAD SYSTEM					

材料 MATERIAL	SEE DRAWING	molex	MOLEX-JAPAN CO.,LTD. 日本モレックス株式会社
仕上げ FINISH	//	EDP. NO.	39-27-6**3
適用電線範囲 WIRE RANGE	//	ENG. NO.	SD-5483-NAX
被覆外径 INS. RANGE	//	REV	F
DRAWN BY '88/8/5 H.HIRAMOTO	CHK'D BY '91/08/30 M.FUKUSHIMA	TITLE 名称	2.5 LOW PROFILE WAFER ASS'Y WITH KINK
APP'D BY '91/08/30 M.ENOMOTO	尺度 SCALE 5 - 1		

5483.S22 A

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